

ESP-WROOM-02DC

Datasheet



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Espressif Systems
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About This Guide

This document provides introduction to the specifications of ESP-WROOM-02DC hardware.

Release Notes

Date	Version	Release notes
2018.10	V0.1	For certification only.

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1.

Overview

ESP-WROOM-02DC is ESP8266EX-based module developed by Espressif. Compared to ESP-WROOM-02D, a two-layer PCB design is applied for ESP-WROOM-02DC.

Note:

For more information on ESP8266EX, please refer to [ESP8266EX Datasheet](#).

Table 1-2. ESP-WROOM-02DC Specifications

Categories	Items	Specifications
Wi-Fi	Wi-Fi protocols	802.11 b/g/n20
	Frequency range	2.4 GHz ~ 2.5 GHz (2412MHz ~ 2462MHz)
Hardware	Peripheral interface	UART/HSPI/I2C/I2S/IR Remote Control GPIO/PWM
	Operating voltage	2.7V ~ 3.6V
	Operating current	Average: 80 mA
	Minimum current delivered by power supply	500 mA
	Operating temperature range	-40°C ~ 85°C
	External interface	-
Software	Wi-Fi mode	Station/SoftAP/SoftAP + Station
	Security	WPA/WPA2
	Encryption	WEP/TKIP/AES
	Firmware upgrade	UART Download/OTA (via network)/Download and write firmware via host
	Software development	Supports Cloud Server Development/SDK for custom firmware development
	Network protocols	IPv4, TCP/UDP/HTTP/FTP
	User configuration	AT Instruction Set, Cloud Server, Android/iOS app



2. Pin Description

Figure 2-1 shows the pin distribution of the ESP-WROOM-02DC.

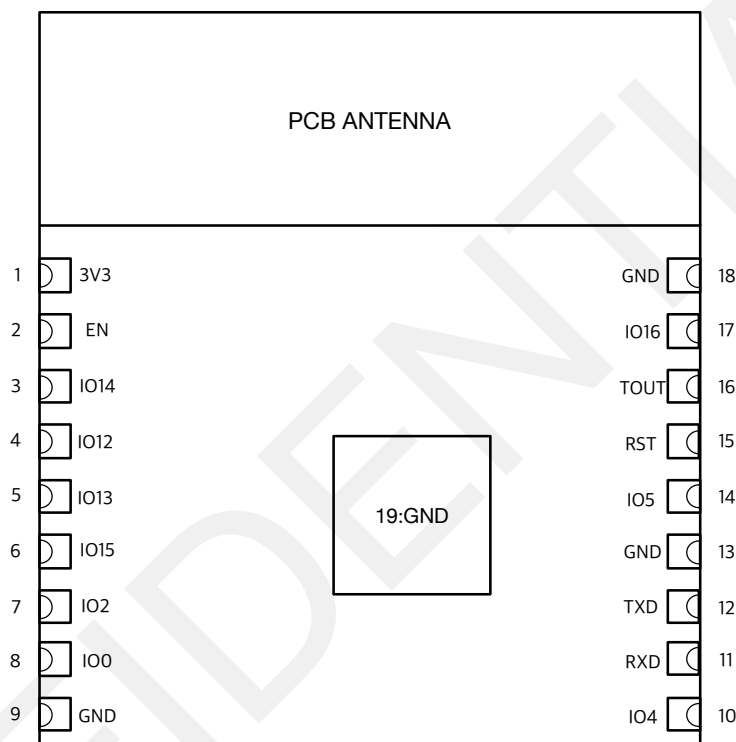


Figure 2-1. ESP-WROOM-02DC Pin Layout (Top View)

ESP-WROOM-02DC has 18 pins. Please see the pin definitions in Table 2-1.

Table 2-1. ESP-WROOM-02DC Pin Definitions

No.	Pin Name	Functional Description
1	3V3	3.3V power supply (VDD) Note: It is recommended the maximum output current a power supply provides be of 500 mA or above.
2	EN	Chip enable pin. Active high.
3	IO14	GPIO14; HSPI_CLK
4	IO12	GPIO12; HSPI_MISO
5	IO13	GPIO13; HSPI_MOSI; UART0_CTS
6	IO15	GPIO15; MTDO; HSPICS; UART0_RTS Pull down.



No.	Pin Name	Functional Description
7	IO2	GPIO2; UART1_TXD Floating (internal pull-up) or pull up.
8	IO0	GPIO0 • UART download: pull down. • Flash boot: floating or pull up.
9	GND	GND
10	IO4	GPIO4
11	RXD	UART0_RXD, receive end in UART download; GPIO3
12	TXD	UART0_TXD, transmit end in UART download, floating or pull up; GPIO1
13	GND	GND
14	IO5	GPIO5
15	RST	Reset
16	TOUT	It can be used to test the power-supply voltage of VDD3P3 (Pin3 and Pin4) and the input power voltage of TOUT (Pin6). These two functions cannot be used simultaneously.
17	IO16	GPIO16; used for Deep-sleep wake-up when connected to RST pin.
18	GND	GND



3. Functional Description

3.1. CPU

The ESP8266EX integrates a Tensilica L106 32-bit RISC processor, which achieves extra-low power consumption and reaches a maximum clock speed of 160 MHz. The Real-Time Operating System (RTOS) and Wi-Fi stack allow 80% of the processing power to be available for user application programming and development. The CPU includes the interfaces as below:

- Programmable RAM/ROM interfaces (iBus), which can be connected with memory controller, and can also be used to visit flash.
- Data RAM interface (dBus), which can connected with memory controller.
- AHB interface which can be used to visit the register.

3.2. Memory

3.2.1. Internal SRAM and ROM

ESP8266EX Wi-Fi SoC integrates the memory controller and memory units including ROM and SRAM. MCU can access the memory units through iBus, dBus, and AHB interfaces. All memory units can be accessed upon request. A memory arbiter determines the running sequence in the arrival order of requests.

According to our current version of SDK, the SRAM space available to users is assigned as follows:

- RAM size < 50 kB, that is, when ESP8266EX is working in Station mode and connects to the router, available space in the Heap + Data sector is around 50 kB.
- There is no programmable ROM in ESP8266EX, therefore, the user program must be stored in an external SPI flash.

3.2.2. SPI Flash

ESP8266EX supports SPI flash. Theoretically speaking, ESP8266EX can support an up-to-16-MB SPI flash.

ESP-WROOM-02DC currently integrates a 2-MB SPI flash and supports these SPI modes: Standard SPI, DIO (Dual I/O), DOUT (Dual Output), QIO (Quad I/O) and QOUT (Quad Output).



3.3. Crystal Oscillator

ESP-WROOM-02DC uses a 26-MHz crystal oscillator. The accuracy of the crystal oscillator should be ± 10 PPM.

When using the download tool, please select the right type of crystal oscillator. In circuit design, capacitors C1 and C2 which connect to the earth are added to the input and output terminals of the crystal oscillator respectively. The values of the two capacitors can be flexible, ranging from 6 pF to 22 pF, however, the specific capacitive values depend on further testing of, and adjustment to, the overall performance of the whole circuit. Normally, the capacitive values of C1 and C2 are within 10 pF for the 26-MHz crystal oscillator.

3.4. Interface Description

Table 3-1. Interface Description

Interface	Pin	Functional Description
HSPI	IO12 (MISO), IO13 (MOSI), IO14 (CLK), IO15 (CS)	Connects to SPI Flash, display screen, and MCU.
PWM	IO12 (R), IO15 (G), IO13 (B)	Currently the PWM interface has four channels, but users can extend it to eight channels. PWM interface can realize the control of LED lights, buzzers, relays, electronic machines, etc.
IR	IO14 (IR_T), IO5 (IR_R)	The functionality of the infrared remote control interface can be realized via software programming. The interface uses NEC coding, modulation, and demodulation. The frequency of the modulated carrier signal is 38 kHz.
ADC	TOUT	Tests the power supply voltage of VDD3P3 (Pin3 and Pin4) and the input power voltage of TOUT (Pin6). However, these two functions cannot be used simultaneously. This interface is typically used in sensors.
I2C	IO14 (SCL), IO2 (SDA)	Connects to external sensors and display screens, etc.
UART	UART0: TXD (U0TXD), RXD (U0RXD), IO15 (RTS), IO13 (CTS) UART1: IO2 (TXD)	Communicates with the UART device. Downloading: U0TXD + U0RXD or GPIO2 + U0RXD Communicating: (UART0): U0TXD, U0RXD, MTDO (U0RTS), MTCK (U0CTS) Debugging: UART1_TXD (GPIO2) can be used to print debugging information. By default, UART0 will output some printed information when you power on ESP8266EX. If this issue influences some specific applications, users can exchange the inner pins of UART when initializing ESP8266EX, that is, exchange U0TXD and U0RXD with U0RTS and U0CTS. Users can connect MTDO and MTCK to the serial port of the external MCU to realize the communication.



Interface	Pin	Functional Description
I2S	I2S input: IO12 (I2SI_DATA) ; IO13 (I2SI_BCK); IO14 (I2SI_WS);	Collects, processes and transmits audio data.
	I2S output: IO15 (I2SO_BCK); IO3 (I2SO_DATA); IO2 (I2SO_WS).	



4. Electrical Characteristics

Note:

Unless otherwise specified, measurements are based on $V_{DD} = 3.3V$, $T_A = 25^{\circ}C$.

4.1. Electrical Characteristics

Table 4-1. Electrical Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Operating temperature	-	-40	20	85	$^{\circ}C$
Maximum soldering temperature (Condition: IPC/JEDEC J-STD-020)	-	-	-	260	$^{\circ}C$
Supply voltage	V_{DD}	2.7	3.3	3.6	V
Input logic level low	V_{IL}	-0.3	-	0.25 V_{DD}	V
Input logic level high	V_{IH}	0.75 V_{DD}	-	$V_{DD} + 0.3$	V
Output logic level low	V_{OL}	-	-	0.1 V_{DD}	V
Output logic level high	V_{OH}	0.8 V_{DD}	-	-	V

4.2. Wi-Fi Radio

Table 4-2. Wi-Fi Radio Characteristics

Description	Min	Typ	Max	Unit
Input frequency	2412	-	2462	MHz
Input reflection	-	-	-10	dB
Output Impedance	-	*	-	Ω
Output Power				
RF output power	20.14	22.91	23.85	dBm
Sensitivity				
DSSS, 1 Mbps	-	-98	-	dBm
CCK, 11 Mbps	-	-91	-	dBm



Description	Min	Typ	Max	Unit
6 Mbps (1/2 BPSK)	-	-93	-	dBm
54 Mbps (3/4 64-QAM)	-	-75	-	dBm
HT20, MCS7 (65 Mbps, 72.2 Mbps)	-	-72	-	dBm
Adjacent channel rejection				
OFDM, 6 Mbps	-	37	-	dB
OFDM, 54 Mbps	-	21	-	dB
HT20, MCS0	-	37	-	dB
HT20, MCS7	-	20	-	dB

Note:

For the module that uses an IPEX antenna, the output impedance is 50Ω.

4.3. Power Consumption

The following power consumption data were obtained from the tests with a 3.3V power supply and a voltage stabilizer, in 25°C ambient temperature. All data are based on 50% duty cycle in continuous transmission mode.

Table 4-3. Power Consumption

Modes	Min	Typ	Max	Unit
Tx 802.11b, CCK 11 Mbps, P _{OUT} = +17 dBm	-	170	-	mA
Tx 802.11g, OFDM 54 Mbps, P _{OUT} = +15 dBm	-	140	-	mA
Tx 802.11n, MCS7, P _{OUT} = +13 dBm	-	120	-	mA
Rx 802.11b, 1024 bytes packet length, -80 dBm	-	50	-	mA
Rx 802.11g, 1024 bytes packet length, -70 dBm	-	56	-	mA
Rx 802.11n, 1024 bytes packet length, -65 dBm	-	56	-	mA
Modem-sleep ^①	-	15	-	mA
Light-sleep ^②	-	0.9	-	mA
Deep-sleep ^③	-	20	-	μA
Power Off	-	0.5	-	μA

**Notes:**

- ① **Modem-sleep** mode is used in the applications that require the CPU to be working, as in PWM or I2S applications. According to 802.11 standards (like U-APSD), it shuts down the Wi-Fi Modem circuit while maintaining a Wi-Fi connection with no data transmission to optimize power consumption. E.g. in DTIM3, maintaining a sleep of 300 ms with a wakeup of 3 ms cycle to receive AP's Beacon packages at interval requires about 15 mA current.
- ② During **Light-sleep** mode, the CPU may be suspended in applications like Wi-Fi switch. Without data transmission, the Wi-Fi Modem circuit can be turned off and CPU suspended to save power consumption according to the 802.11 standards (U-APSD). E.g. in DTIM3, maintaining a sleep of 300 ms with a wakeup of 3ms to receive AP's Beacon packages at interval requires about 0.9 mA current.
- ③ During **Deep-sleep** mode, Wi-Fi is turned off. For applications with long time lags between data transmission, e.g. a temperature sensor that detects the temperature every 100s, sleeps for 300s and wakes up to connect to the AP (taking about 0.3 ~ 1s), the overall average current is less than 1mA. The current of 20 μ A is acquired at the voltage of 2.5V.

4.4. Reflow Profile

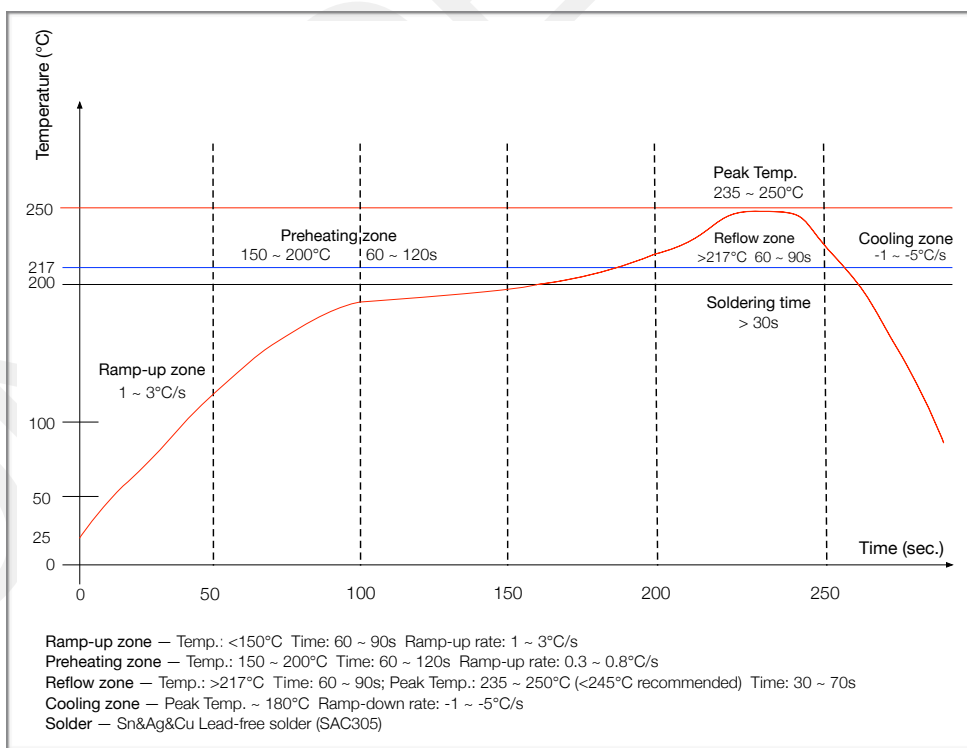


Figure 4-1. ESP-WROOM-02DC Reflow Profile



4.5. Electrostatic Discharge

Table 4-4. Electrostatic Discharge Parameters

Name	Symb ol	Reference	Level	Max	Unit
Electrostatic Discharge (Human - Body Model)	V _{ESD} (HBM)	Temperature: 23 ± 5°C Based on ANSI/ESDA/JEDEC JS - 001 - 2014	2	2000	V
Electrostatic Discharge (Charged - Device Model)	V _{ESD} (CDM)	Temperature: 23 ± 5°C Based on JEDEC EIA/JESD22 - C101F	C2	500	



5.

Dimensions

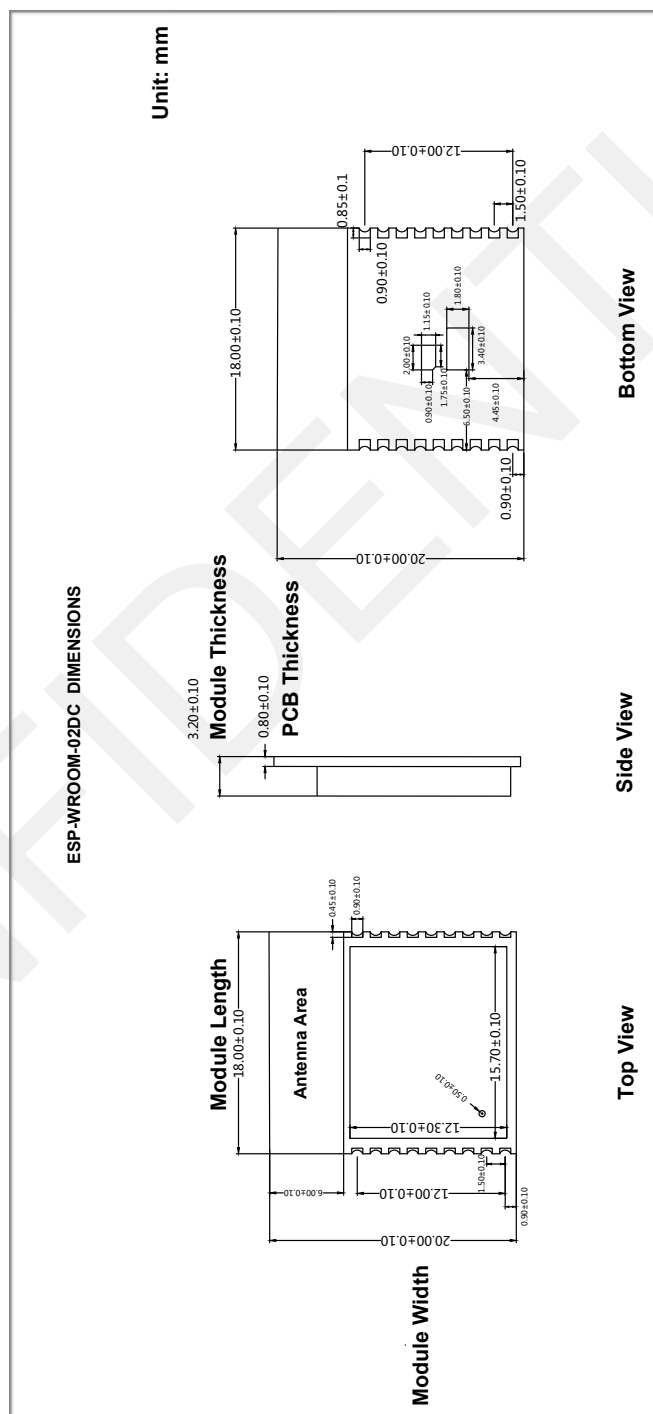


Figure 7-1. ESP-WROOM-02DC Dimensions



Figure 8-1. Recommended PCB Land Pattern of ESP-WROOM-02DC



A. Appendix—Learning Resources

A.1. Must-Read Documents

- [*ESP8266 Quick Start Guide*](#)

Description: This document is a quick user guide to getting started with ESP8266. It includes an introduction to the ESP-LAUNCHER, how to download firmware on to the board and run it, how to compile the AT application, structure and the debugging method of RTOS SDK. Basic documentation and other related resources for the ESP8266 are also provided.

- [*ESP8266 SDK Getting Started Guide*](#)

Description: This document takes ESP-LAUNCHER and ESP-WROOM-02 as examples to introduce how to use ESP8266 SDK. The contents include preparations before compilation, SDK compilation and firmware download.

- [*ESP-WROOM-02 PCB Design and Module Placement Guide*](#)

Description: The ESP-WROOM-02 module is designed to be soldered to a host PCB. This document compares six different placements of the antenna on a host board and provides notes on designing PCB.

- [*ESP8266 Hardware Resources*](#)

Description: This zip package includes manufacturing specifications of the ESP8266 board and the modules, manufacturing BOM and schematics.

- [*ESP8266 AT Command Examples*](#)

Description: This document introduces some specific examples of using Espressif AT commands, including single connection as a TCP Client, UDP transmission and transparent transmission, and multiple connection as a TCP server.

- [*ESP8266 AT Instruction Set*](#)

Description: This document provides lists of AT commands based on ESP8266_NONOS_SDK, including user-defined AT commands, basic AT commands, Wi-Fi AT commands and TCP/IP-related AT commands. It also introduces the downloading of AT firmware into flash.

- [*TCP/UDP UART Passthrough Test Demonstration*](#)

Description: This guide is intended to help users run a TCP & UDP passthrough test on the ESP8266 IoT platform.



- [FAQ](#)

A.2. Must-Have Resources

- [ESP8266 SDKs](#)

Description: This website page provides links to the latest version of ESP8266 SDK and the older ones.

- [ESP8266 Tools](#)

Description: This website page provides links to the ESP8266 flash download tools and ESP8266 performance evaluation tools.

- [ESP8266 App](#)
- [ESP8266 Certification and Test Guide](#)
- [ESP8266 BBS](#)
- [ESP8266 Resources](#)

FCC Statement

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) This device must accept any interference received, including interference that may cause undesired operation.

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

FCC Label Instructions

The outside of final products that contains this module device must display a label referring to the enclosed module. This exterior label can use wording such as: "Contains Transmitter Module FCC ID:2AC7Z-ESPWROOM02DC" or "Contains FCC ID:2AC7Z-ESPWROOM02DC" Any similar wording that expresses the same meaning may be used.



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